

2MBI1200XXE120P-50

IGBT Modules

Power Module (X series)
1200V / 1200A / 2-in-1 package

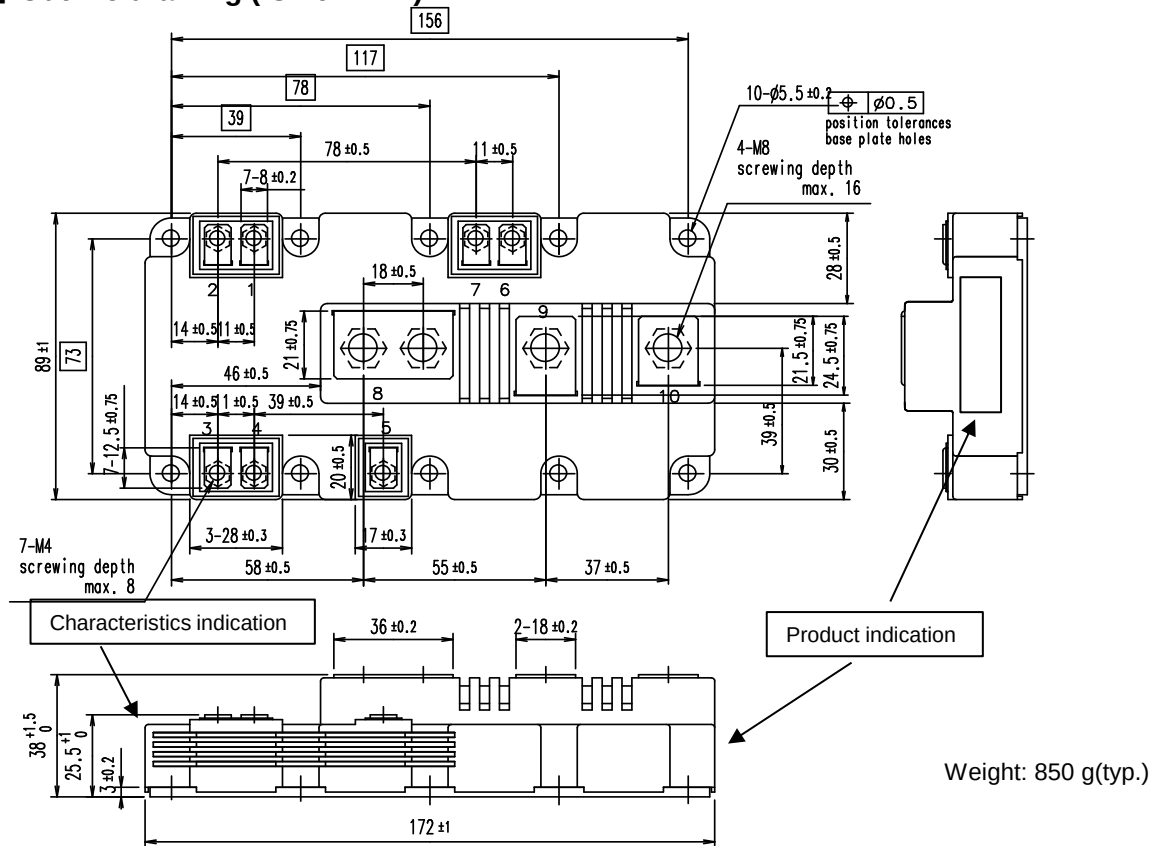
■ Features

- LOW $V_{CE(sat)}$
- Low Inductance Module structure

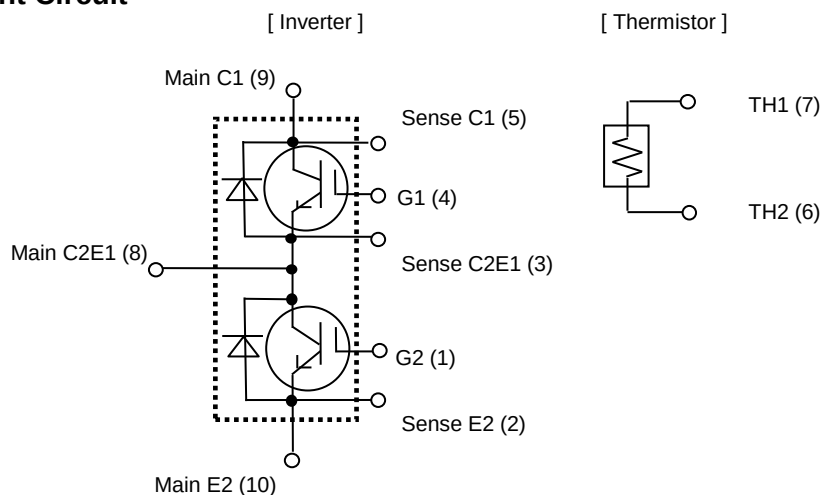
■ Applications

- Inverter for Motor Drives, AC and DC Servo Drives
- Uninterruptible Power Supply Systems, Wind Turbines, PV Power Conditioning Systems

■ Outline drawing (Unit : mm)



■ Equivalent Circuit



2MBI1200XXE120P-50

IGBT Modules
■ Absolute Maximum Ratings (at $T_c = 25^\circ\text{C}$ unless otherwise specified)

Items			Symbols	Conditions	Maximum Ratings	Units	
Inverter	Collector-emitter voltage, gate-emitter short-circuited		V_{CES}			1200	V
	Gate-emitter voltage, collector-emitter short-circuited		V_{GES}			±20	V
	Collector current		I_C	Continuous	$T_C=100^{\circ}\text{C}$	1200	A
	Repetitive peak collector current		I_{CRM}	1ms		2400	
	Forward current		I_F			1200	
	Repetitive peak forward current		I_{FRM}	1ms		2400	
	Total power dissipation		P_{tot}	1 device		7.1	W
	Virtual junction temperature		T_{vj}			175	$^{\circ}\text{C}$
	Operating virtual junction temperature (under switching conditions)		T_{vjop}			175	
	Case temperature		T_c			150	
	Storage temperature		T_{stg}			-40 ~ 150	
	Isolation voltage	between terminal and copper base (*1)	V_{isol}	AC: 1min.		4000	Vrms
	between thermistor and others (*2)						
Mounting torque of screws to heatsink (*3)			M_s	M5		6.0	N·m
Mounting torque of screws to main terminals (*3)			M_t	M8		10.0	
Mounting torque of screws to sense terminals (*3)				M4		2.1	

(*1) All terminals should be connected together during the test.

(*2) Two thermistor terminals should be connected together, other terminals should be connected together and shorted to base plate during the test.

(*3) Recommendable Value: : Mounting torque of screws to heatsink 3.0 ~ 6.0 N·m (M5)
 : Mounting torque of screws to main terminals 8.0~ 10.0 N·m (M8)
 : Mounting torque of screws to sense terminals 1.8~ 2.1 N·m (M4)

2MBI1200XXE120P-50

IGBT Modules
■ Electrical characteristics (at $T_{vj}=25^{\circ}\text{C}$ unless otherwise specified)

Items		Symbols	Conditions		Characteristics			Units
					min.	typ.	max.	
Inverter	Collector-emitter cut-off current, gate-emitter short-circuited	I_{CES}	$V_{GE} = 0V$ $V_{CE} = 1200V$		-	-	400	μA
	Gate leakage current, collector-emitter short-circuited	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 20V$		-	-	800	nA
	Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = 20V$ $I_C = 1200mA$		6.0	6.5	7.0	V
	Collector-emitter saturation voltage	$V_{CE(sat)}$ (terminal)	$V_{GE} = 15V$ $I_C = 1200A$	$T_{vj}=25^{\circ}C$	-	1.50	1.95	V
		$V_{CE(sat)}$ (chip)		$T_{vj}=25^{\circ}C$	-	1.45	1.90	
				$T_{vj}=125^{\circ}C$	-	1.70	-	
				$T_{vj}=150^{\circ}C$	-	1.75	-	
				$T_{vj}=175^{\circ}C$	-	1.85	-	
	Internal gate resistance	r_g	-		-	3.13	-	Ω
	Capacitance	C_{ies}	$V_{CE}=10V, V_{GE}=0V, f=1MHz$		-	128	-	nF
		C_{oes}			-	4.4	-	
		C_{res}			-	1.1	-	
	Gate charge	Q_G	$V_{CC} = 600V, I_C = 1200A$ $V_{GE} = -15 \rightarrow +15V$		-	8.3	-	μC
	Forward voltage	V_F (terminal)	$V_{GE} = 0V$ $I_F= 1200A$	$T_{vj}=25^{\circ}C$	-	1.65	2.10	V
		V_F (chip)		$T_{vj}= 25^{\circ}C$	-	1.60	2.05	
				$T_{vj}=125^{\circ}C$	-	1.65	-	
				$T_{vj}=150^{\circ}C$	-	1.60	-	
				$T_{vj}=175^{\circ}C$	-	1.60	-	
	Switching time (*1)	$t_{d(on)}$	$V_{CC} = 600V$ $I_C, I_F= 1200A$ $V_{GE} = +15/-15 V$ $R_G = +0.82/-0.82 \Omega$ $L_S = 60 nH$	$T_{vj}= 25^{\circ}C$	-	1.10	-	μs
				$T_{vj}=125^{\circ}C$	-	1.10	-	
$T_{vj}=150^{\circ}C$				-	1.10	-		
$T_{vj}=175^{\circ}C$				-	1.10	-		
t_r		$T_{vj}= 25^{\circ}C$		-	0.20	-		
		$T_{vj}=125^{\circ}C$		-	0.22	-		
		$T_{vj}=150^{\circ}C$		-	0.22	-		
		$T_{vj}=175^{\circ}C$		-	0.22	-		
$t_{d(off)}$		$T_{vj}= 25^{\circ}C$		-	0.90	-		
		$T_{vj}=125^{\circ}C$		-	0.94	-		
		$T_{vj}=150^{\circ}C$		-	0.96	-		
		$T_{vj}=175^{\circ}C$		-	0.97	-		
t_f		$T_{vj}= 25^{\circ}C$		-	0.16	-		
		$T_{vj}=125^{\circ}C$		-	0.17	-		
		$T_{vj}=150^{\circ}C$		-	0.18	-		
		$T_{vj}=175^{\circ}C$		-	0.20	-		
Reverse recovery time	t_{rr}	$T_{vj}= 25^{\circ}C$	-	0.29	-			
		$T_{vj}=125^{\circ}C$	-	0.47	-			
		$T_{vj}=150^{\circ}C$	-	0.49	-			
		$T_{vj}=175^{\circ}C$	-	0.52	-			

(*1) Turn on time (t_{on}) = $t_{d(on)} + t_r$, Turn off time (t_{off}) = $t_{d(off)} + t_f$

2MBI1200XXE120P-50

IGBT Modules
■ Electrical characteristics (at $T_{vj}=25^{\circ}\text{C}$ unless otherwise specified)

Items		Symbols	Conditions		Characteristics			Units
					min.	typ.	max.	
Inverter	Switching loss (per pulse)	E_{on}	$V_{\text{CC}} = 600\text{V}$ $I_{\text{C}}, I_{\text{F}} = 1200\text{A}$ $V_{\text{GE}} = +15/-15\text{ V}$ $R_{\text{G}} = +0.82/-0.82\ \Omega$ $L_{\text{S}} = 60\text{ nH}$	$T_{\text{vj}} = 25^{\circ}\text{C}$	-	110	-	mJ
				$T_{\text{vj}} = 125^{\circ}\text{C}$	-	165	-	
				$T_{\text{vj}} = 150^{\circ}\text{C}$	-	172	-	
				$T_{\text{vj}} = 175^{\circ}\text{C}$	-	185	-	
		E_{off}		$T_{\text{vj}} = 25^{\circ}\text{C}$	-	164	-	
				$T_{\text{vj}} = 125^{\circ}\text{C}$	-	209	-	
				$T_{\text{vj}} = 150^{\circ}\text{C}$	-	220	-	
				$T_{\text{vj}} = 175^{\circ}\text{C}$	-	227	-	
		E_{rr}		$T_{\text{vj}} = 25^{\circ}\text{C}$	-	48	-	
				$T_{\text{vj}} = 125^{\circ}\text{C}$	-	74	-	
				$T_{\text{vj}} = 150^{\circ}\text{C}$	-	88	-	
				$T_{\text{vj}} = 175^{\circ}\text{C}$	-	98	-	
Thermistor	Resistance	R	$T = 25^{\circ}\text{C}$	-	5000	-	Ω	
			$T = 100^{\circ}\text{C}$	465	495	520		
	B value	B	$T = 25/ 50^{\circ}\text{C}$	3305	3375	3450	K	

NOTICE:

The external gate resistance (R_G) shown above is one of our recommended value for the purpose of minimum switching loss. However the optimum R_G depends on circuit configuration and/or environment. We recommend that the R_G has to be carefully chosen based on consideration if IGBT module matches design criteria, for example, switching loss, EMC/EMI, spike voltage, surge current and no unexpected oscillation and so on.

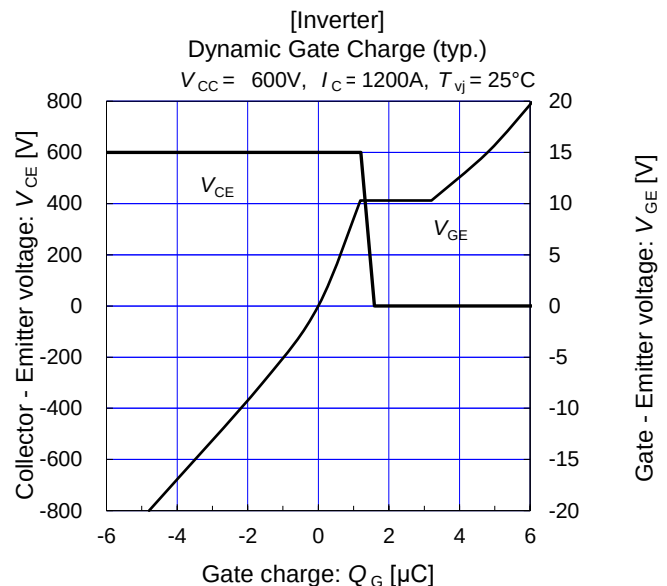
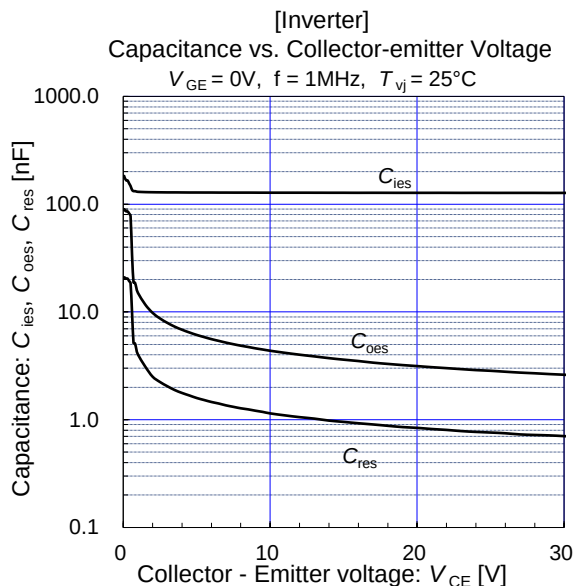
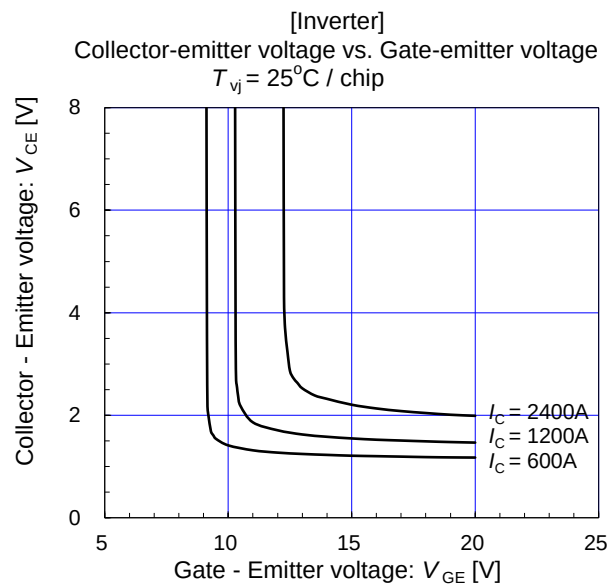
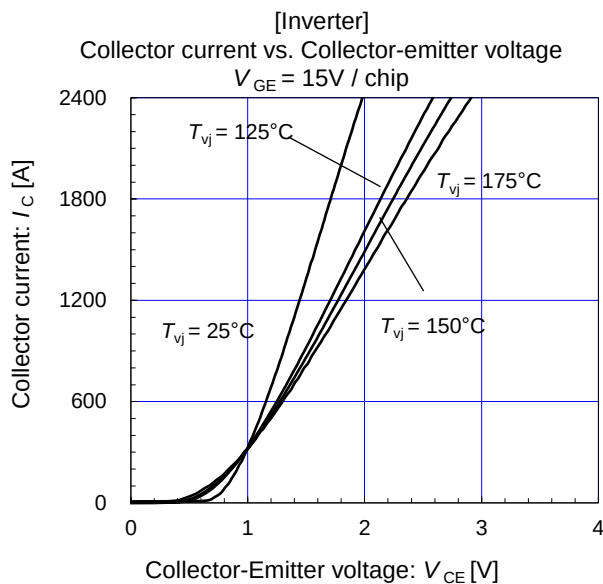
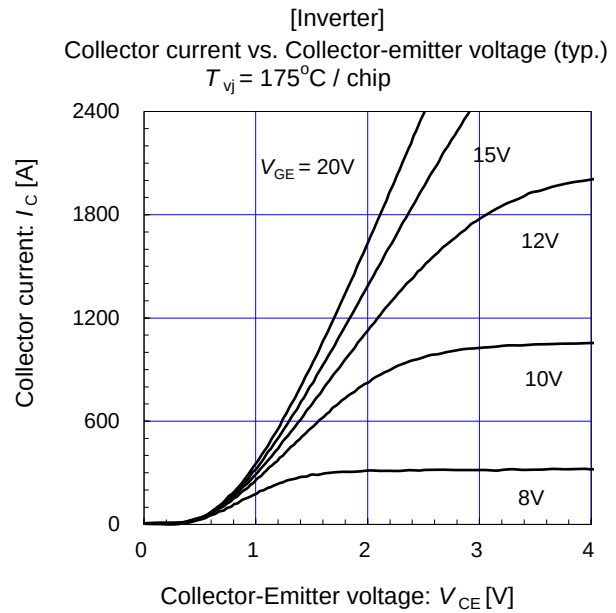
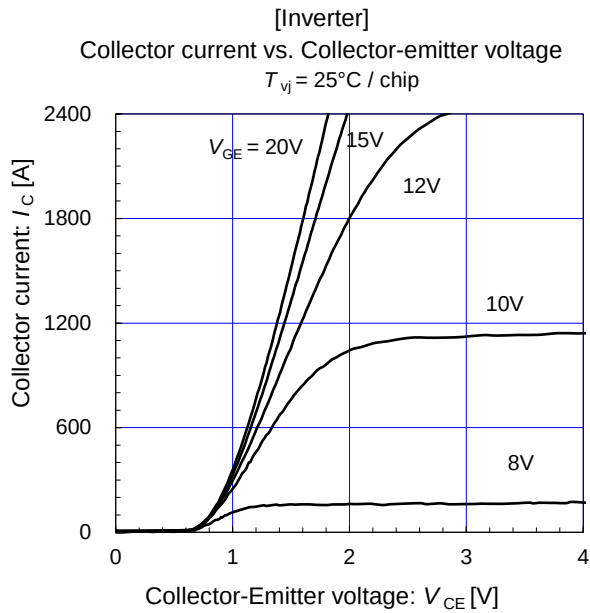
■ Thermal resistance characteristics

Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	
Thermal resistance junction to case(1 device)	$R_{th(j-c)}$	Inverter IGBT	-	-	21.0	K/kW
		Inverter FWD	-	-	34.5	
Thermal resistance case to heatsink(1 IGBT+1 FWD) (*1)	$R_{th(c-s)}$	with 1 W/(m·K) thermal grease	-	6.3	-	

(*1) This is the value which is defined mounting on the additional heatsink with thermal grease.

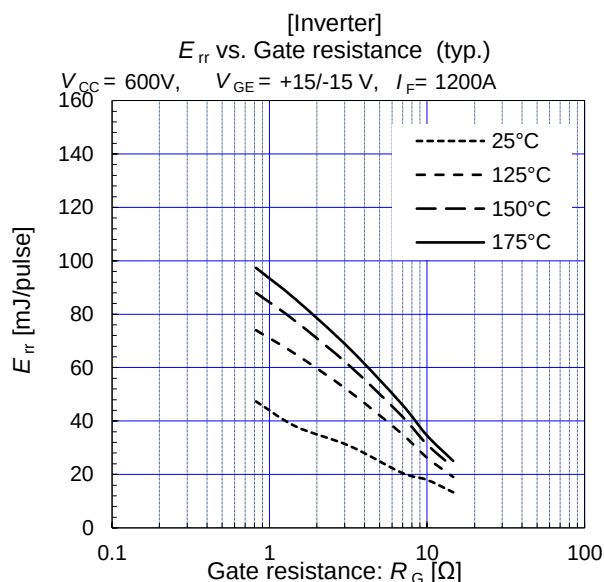
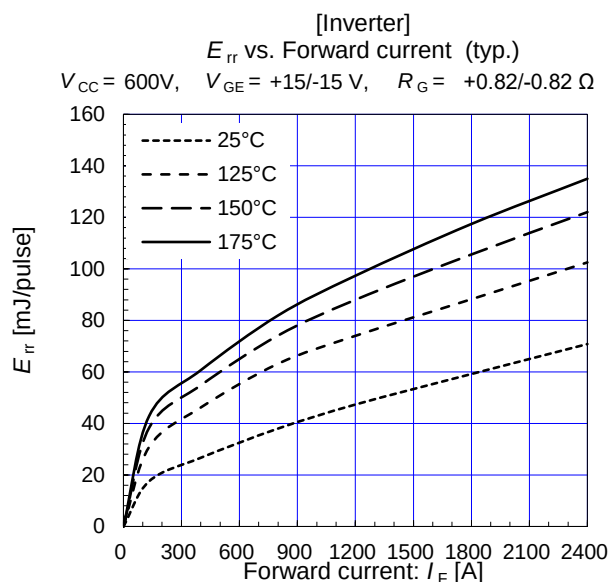
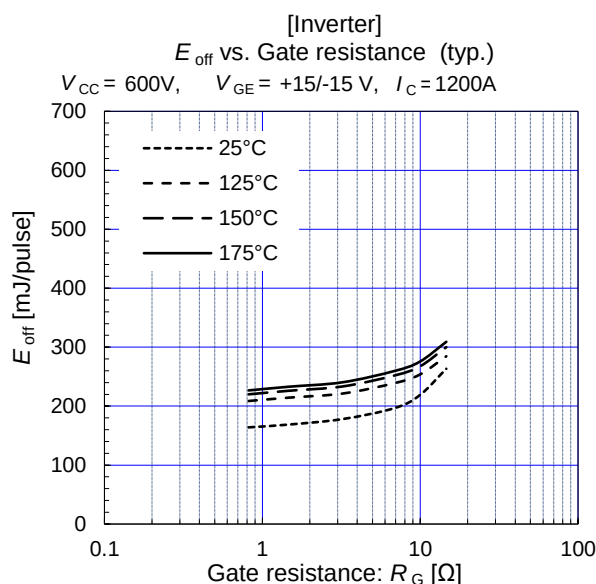
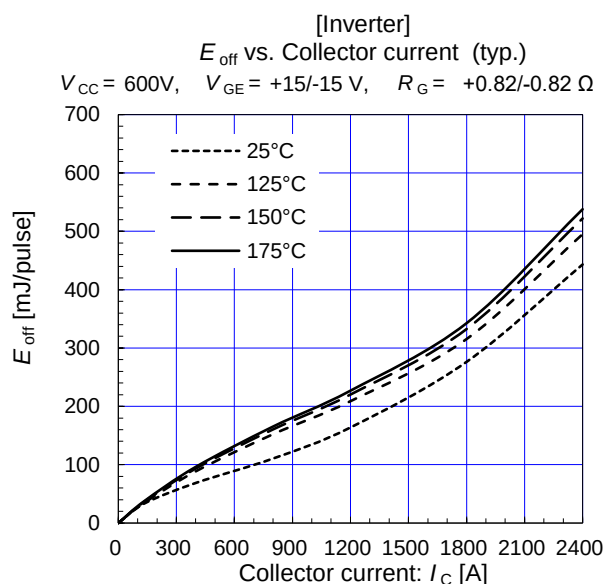
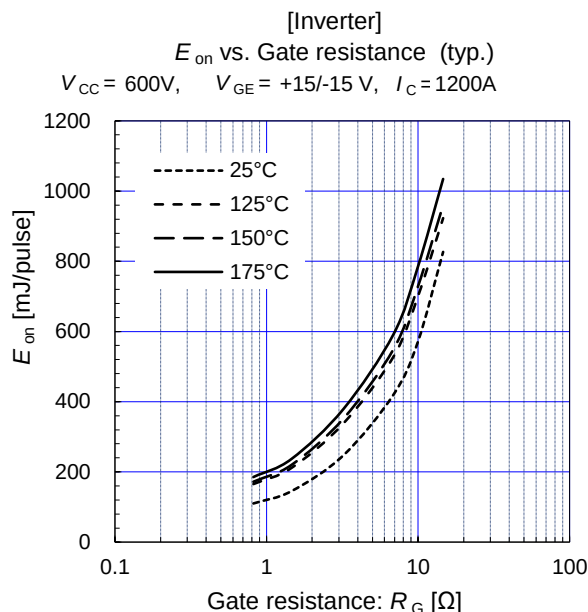
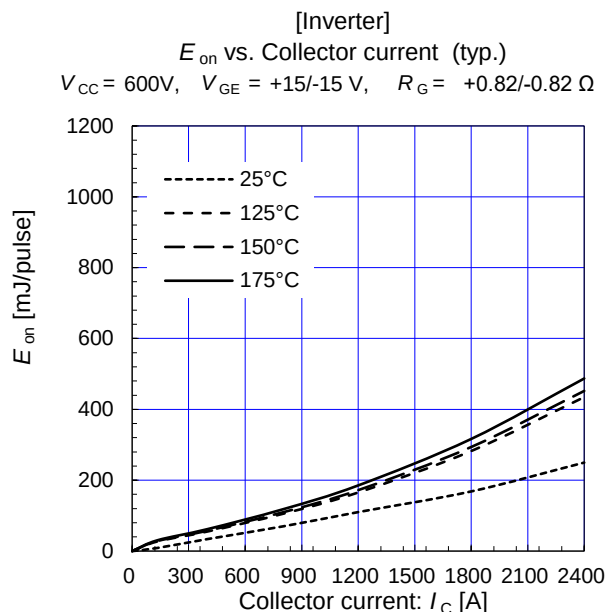
2MBI1200XXE120P-50

IGBT Modules



2MBI1200XXE120P-50

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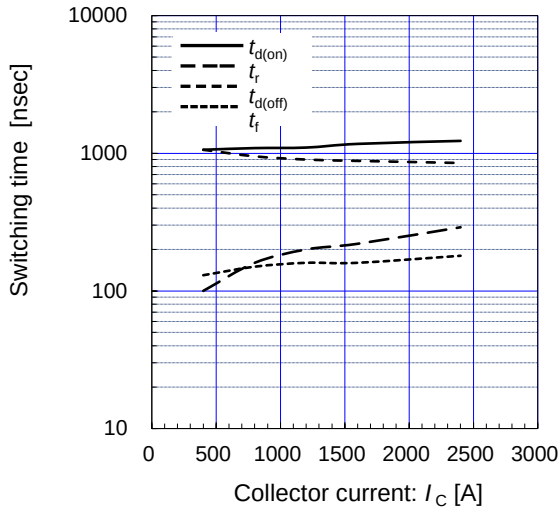
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[Inverter]

Switching time vs. Collector current (typ.)

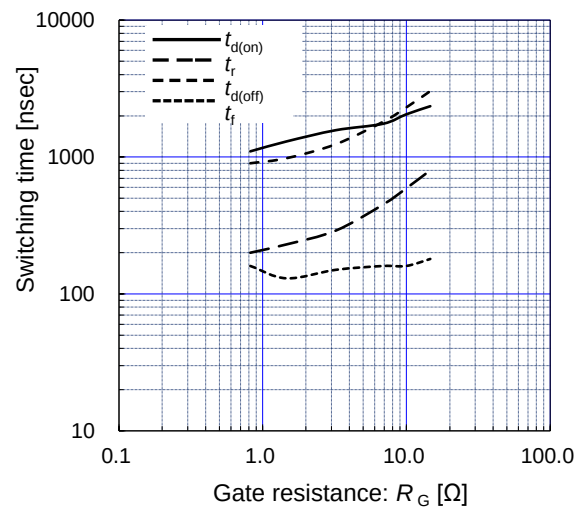
$V_{CC} = 600V$, $R_G = +0.82/-0.82 \Omega$, $V_{GE} = +15/-15 V$, $T_{vj} = 25^\circ C$



[Inverter]

Switching time vs. Gate resistance (typ.)

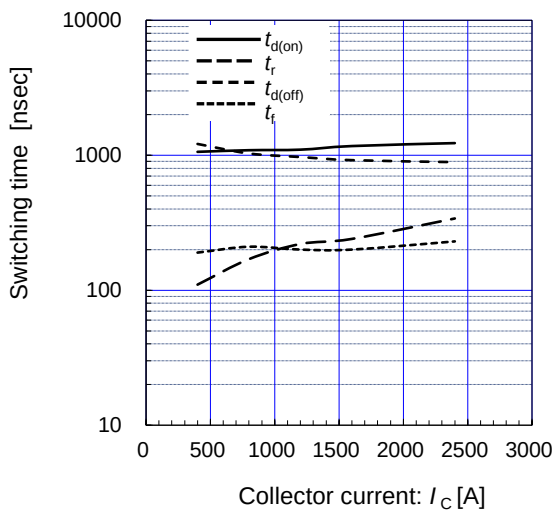
$V_{CC} = 600V$, $I_C = 1200A$, $V_{GE} = +15/-15 V$, $T_{vj} = 25^\circ C$



[Inverter]

Switching time vs. Collector current (typ.)

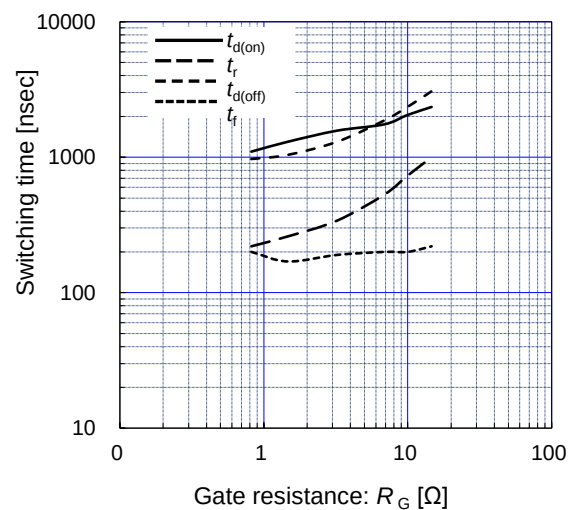
$V_{CC} = 600V$, $R_G = +0.82/-0.82 \Omega$, $V_{GE} = +15/-15 V$, $T_{vj} = 175^\circ C$



[Inverter]

Switching time vs. Gate resistance (typ.)

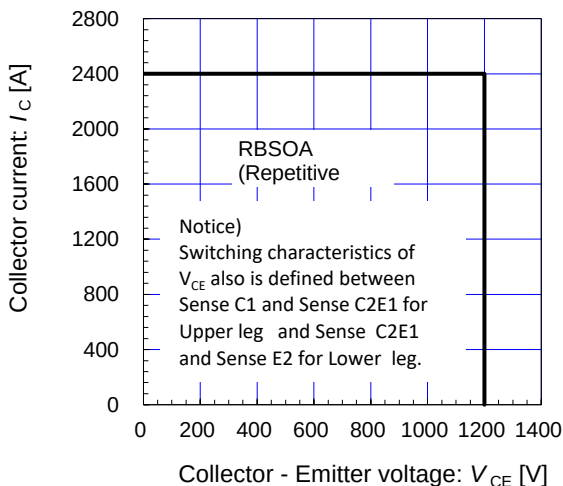
$V_{CC} = 600V$, $I_C = 1200A$, $V_{GE} = +15/-15 V$, $T_{vj} = 175^\circ C$



[Inverter]

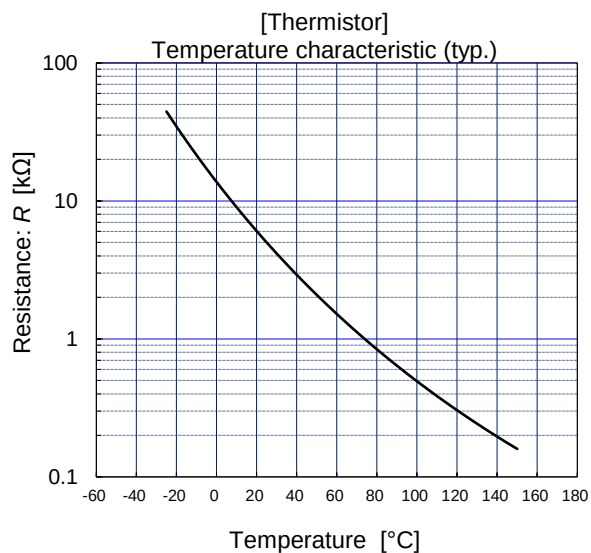
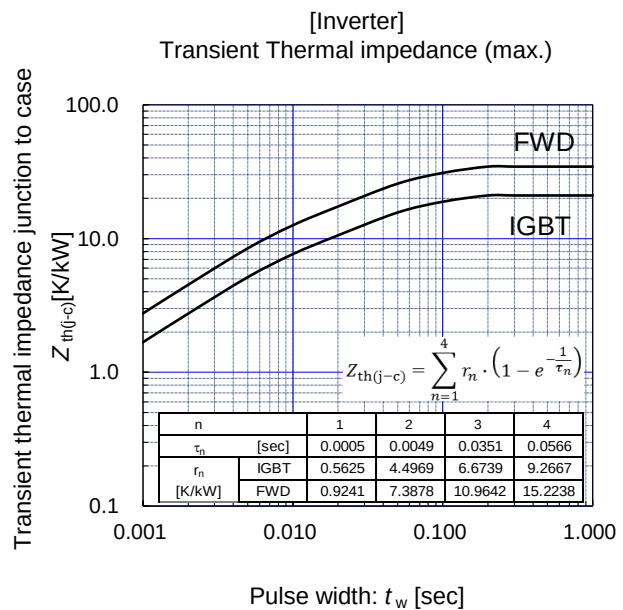
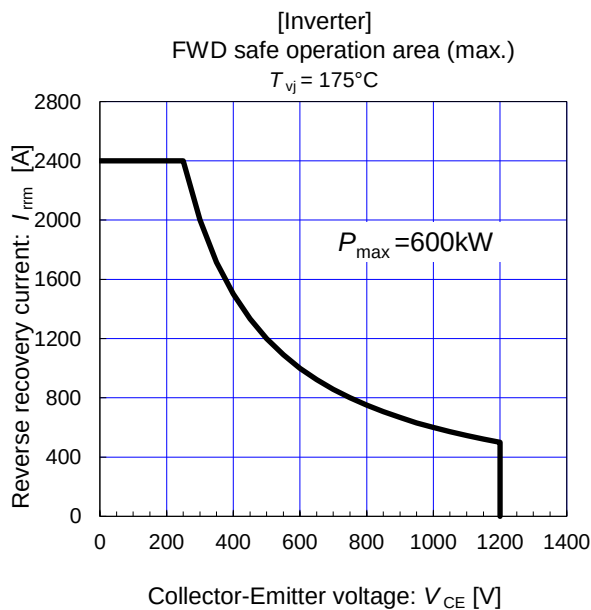
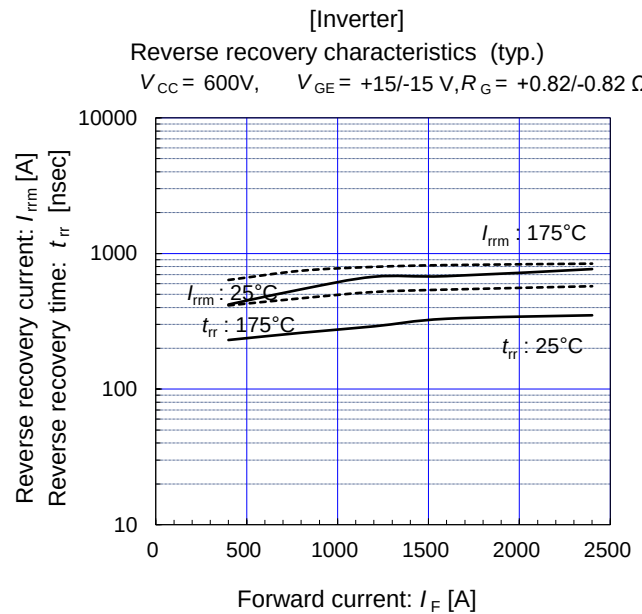
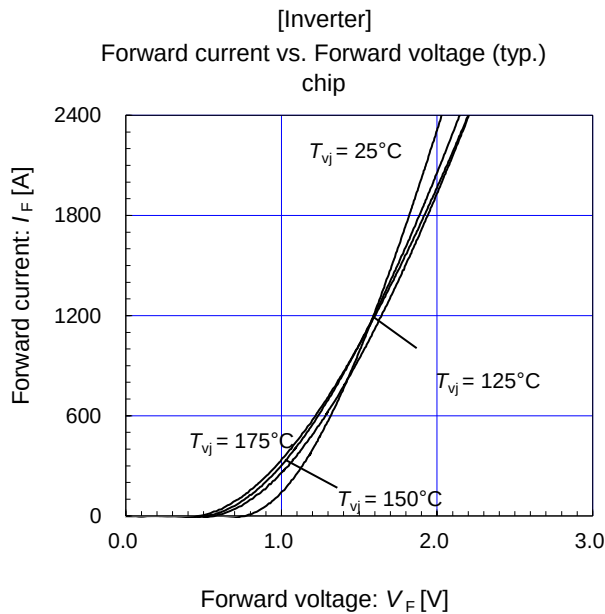
Reverse bias safe operating area (max.)

$V_{GE} = +15/-15 V$, $R_G = +0.82/-0.82 \Omega$, $T_{vj} = 175^\circ C$



2MBI1200XXE120P-50

IGBT Modules



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